



### P-CHANNEL ENHANCEMENT MODE MOSFET

## **Features**

- Low On-Resistance
- Very Low Gate Threshold Voltage V<sub>GS(th)</sub> < 1V
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Alloy 42
  leadframe. Solderable per MIL-STD-202, Method 208 ④
- Terminal Connections: See Diagram
- Weight: 0.006 grams (approximate)







Drain

Equivalent Circuit

Top View

D

## Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2004WK-7	SOT323	3000/Tape & Reel

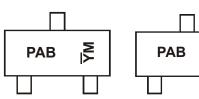
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/guality/lead free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

Notes:

3. Halogen - and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



PAB = Product Type Marking Code YM = Date Code Marking for SAT (Shanghai Assembly/ Test site)  $\overline{Y}M$  = Date Code Marking for CAT (Chengdu Assembly/ Test site) Y or  $\overline{Y}$  = Year (ex: A = 2013) M = Month (ex: 9 = September)

Chengdu A/T Site

Date Code Key	,											
Year	2007	2008	2009	2010	) 201	1 20	)12	2013	2014	2015	2016	2017
Code	U	V	W	Х	Y		Z	А	В	С	D	E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D

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Shanghai A/T Site

See http://www and Lead-free.



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Drain-Source Voltage	V <sub>DSS</sub>	-20	V
Gate-Source Voltage	V <sub>GSS</sub>	±8	V
Drain Current (Note 5)	I <sub>D</sub>	-400	mA
Pulsed Drain Current	I <sub>DM</sub>	-1.4	А

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	Pd	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	500	°C/W
Operating and Storage Temperature Range	T <sub>j,</sub> T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

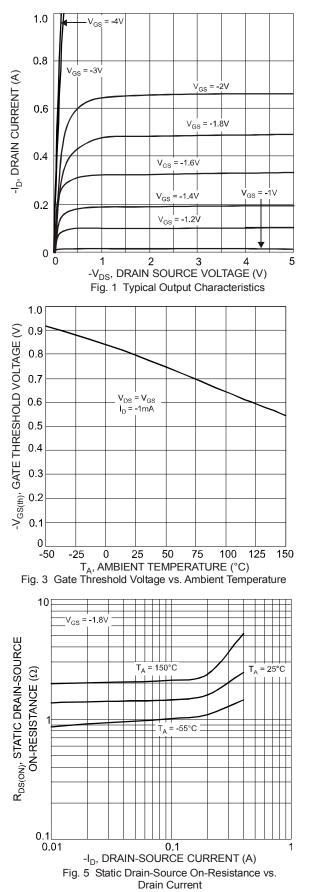
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)		•					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	_		V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250µA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	-1.0	μA	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±1.0	μA	$V_{GS}$ = ±4.5V, $V_{DS}$ = 0V	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.5	_	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
		_	0.7 1.1 1.7	0.9 1.4 2.0	Ω	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -430mA	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>					V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -300mA	
						V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -150mA	
Forward Transfer Admittance	Y <sub>fs</sub>	200	_	_	mS	V <sub>DS</sub> =10V, I <sub>D</sub> = -0.2A	
Diode Forward Voltage (Note 6)	V <sub>SD</sub>	-0.5		-1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -115mA	
DYNAMIC CHARACTERISTICS (Note 7)		•				·	
Input Capacitance	Ciss	_	_	175	pF		
Output Capacitance	C <sub>oss</sub>	_	_	30	pF	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	—	—	20	pF		

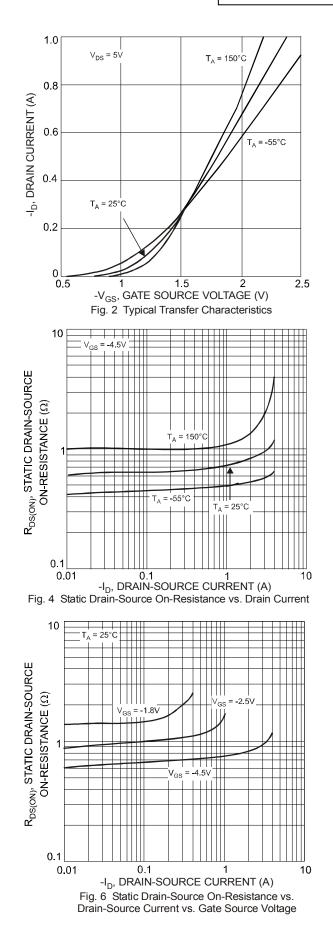
Notes: 5. Device mounted on FR-4 PCB.

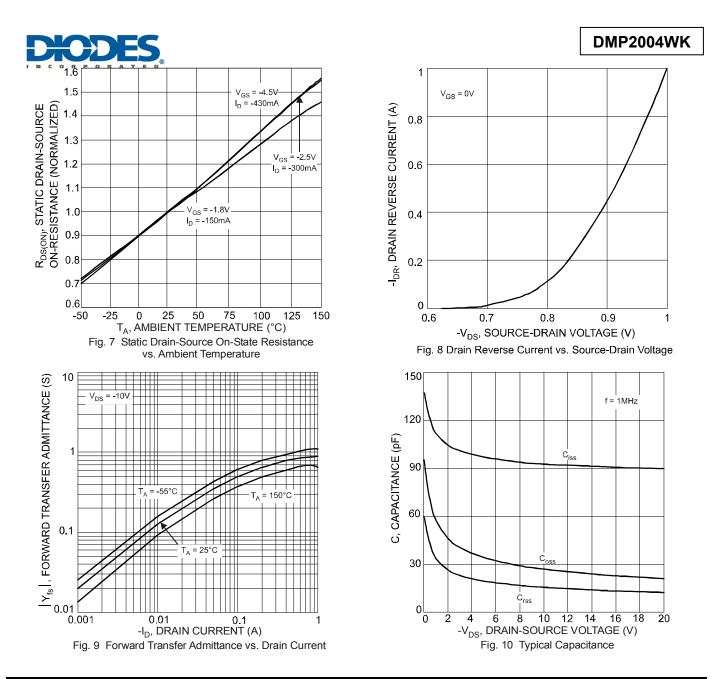
6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to production testing.

# DMP2004WK



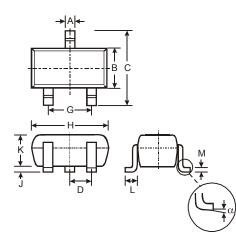






# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

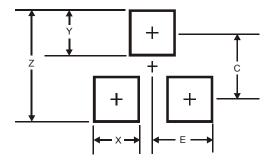


SOT323						
Dim	Min	Max	Тур			
Α	0.25	0.40	0.30			
В	1.15	1.35	1.30			
C	2.00	2.20	2.10			
D	-	-	0.65			
G	1.20	1.40	1.30			
Н	1.80	2.20	2.15			
J	0.0	0.10	0.05			
κ	0.90	1.00	0.95			
L	0.25	0.40	0.30			
М	0.10	0.18	0.11			
α	0°	8°	-			
All Dimensions in mm						



## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0

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